



100V NPN HIGH PERFORMANCE TRANSISTOR IN PowerDI3333-8

Features

- $BV_{CEO} > 100V$
- Small Form Factor Thermally Efficient Package. Enables Higher **Density End Products**
- I_C = 2A High Continuous Current
- I_{CM} = 6A Peak Pulse Current
- Low Saturation Voltage V_{CE(SAT)} < 250mV @ 1A
- Complementary PNP Type: DXTP07100BFG
- Rated to +175°C-Ideal for High Temperature Environment
- Wettable Flank for Improved Optical Inspection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

PowerDI3333-8 (SWP) (Type UX)

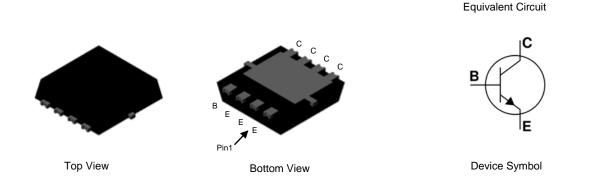
Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.03 grams (Approximate)

Applications

- Load Switch
- Linear Regulator
- MOSFET or IGBT Gate Driving



Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DXTN07100BFG-7	2H7	7	12	2,000
Notes: 1. No purposely added lead, Fully EU Directive 2002/95/EC (RoHS). 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.				

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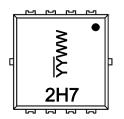
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

PowerDI3333-8 (SWP) (Type UX)



2H7 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 = 2018) WW = Week Code (01 to 53)



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Collector-Base Voltage	V _{CBO}	120	V	
Collector-Emitter Voltage	V _{CEO}	100	V	
Emitter-Base Voltage	V _{EBO}	7	V	
Continuous Collector Current	lc	2	А	
Peak Pulse Current	I _{CM}	6	A	

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
	(Note 5)		0.9	W
Power Dissipation	(Note 6)	PD	2.1	W
	(Note 7)		3.1	W
	(Note 5)		140	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{ ext{ heta}JA}$	65	°C/W
	(Note 7)		44	°C/W
Thermal Resistance, Junction to Leads (Note 8)		$R_{ ext{ heta}JL}$	8.5	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +175	°C	

ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge—Human Body Model	ESD HBM	4000	V	ЗA
Electrostatic Discharge—Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted with the collector tab on MRP FR4-PCB; device is measured under still air conditions whilst operating in a steady-state.

6. Same as Note 5, except the device is mounted on 25mm × 25mm 2oz copper.

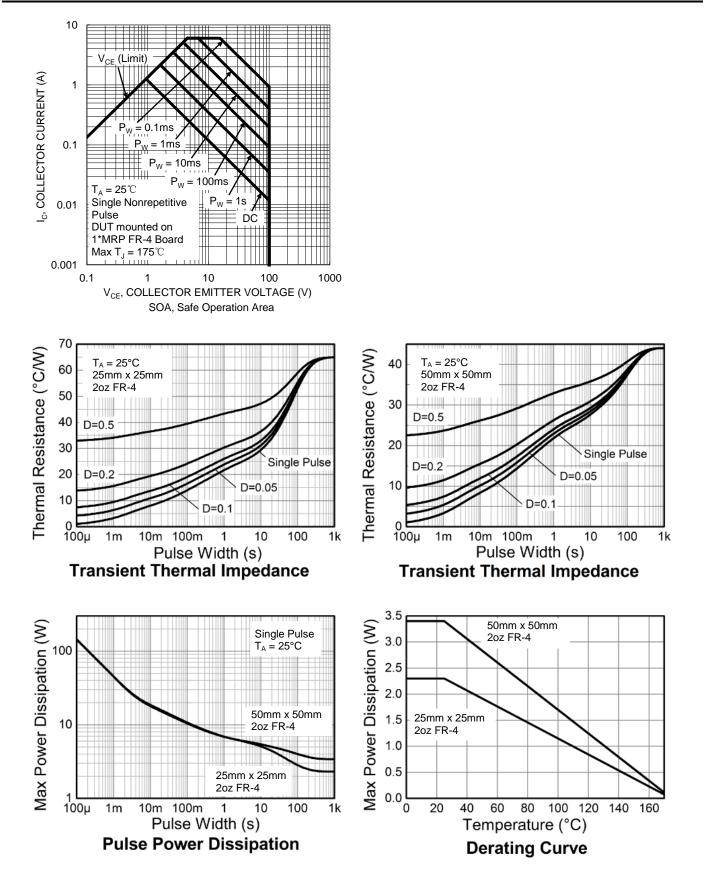
7. Same as Note 5, except the device is mounted on 50mm × 50mm 2oz copper.

8. Thermal resistance from junction to solder-point (at the collector tab).

9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





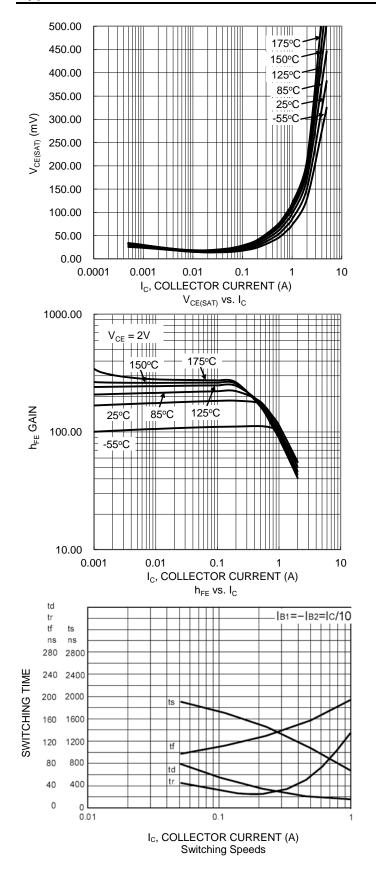
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

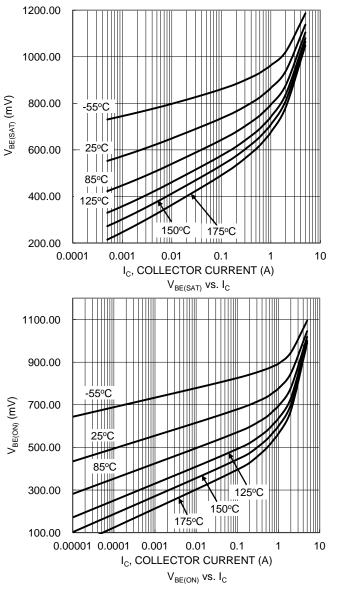
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	120	264		V	I _C = 100μA
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	100	129		V	$I_{C} = 10 \text{mA}$
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.4	_	V	I _E = 100μA
Collector Cut-Off Current		—	_	50	nA	V _{CB} = 100V
	I _{CBO}	—	—	10	μA	$V_{CB} = 100V, T_A = +125^{\circ}C$
Emitter Cut-Off Current	I _{EBO}	—	—	20	nA	$V_{EB} = 6V$
Collector Emitter Seturation Voltage (Note 10)	Manua (1997)	_	90	250	mV	$I_{\rm C} = 1$ A, $I_{\rm B} = 100$ mA
Collector-Emitter Saturation Voltage (Note 10)	VCE(SAT)	—	150	400	mV	$I_{\rm C} = 2A, I_{\rm B} = 200 {\rm mA}$
Base-Emitter Saturation Voltage (Note 10)	V _{BE(SAT)}	—	0.86	1	V	$I_{\rm C} = 1$ A, $I_{\rm B} = 100$ mA
Base-Emitter Turn-On Voltage (Note 10)	V _{BE(ON)}	—	0.79	0.95	V	$I_C = 1A, V_{CE} = 2V$
	hre	70	183	_	_	$I_{C} = 50 \text{mA}, V_{CE} = 2 \text{V}$
DC Current Gain (Note 10)		100	172	300	_	$I_{C} = 500 \text{mA}, V_{CE} = 2 \text{V}$
DC Current Gain (Note 10)		55	113	_	_	$I_C = 1A, V_{CE} = 2V$
		25	56	_	_	$I_C = 2A, V_{CE} = 2V$
Current Gain-Bandwidth Product	f _T	140	175	—	MHz	$V_{CE} = 5V$, $I_C = 100$ mA, f = 100MHz
Switching Time	t _{ON}	_	80	_	ns	$I_{C} = 500 \text{mA}, V_{CC} = 10 \text{V},$
Switching Time	tOFF	_	1200		ns	$I_{B1} = -I_{B2} = 50 \text{mA}$
Output Capacitance	Сово		—	30	pF	V _{CB} = 10V, f = 1MHz

Note: 10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



Typical Electrical Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)



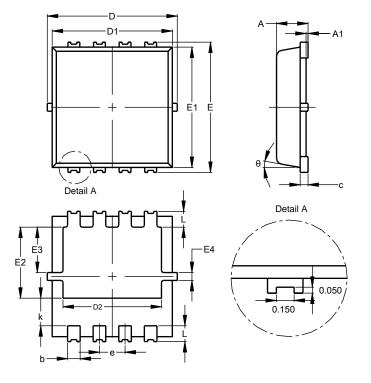




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (SWP) (Type UX)

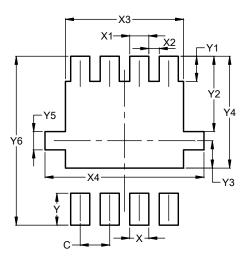


PowerDI3333-8 (SWP)					
(Type UX)					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05			
b	0.25	0.40	0.32		
С	0.10	0.25	0.15		
D	3.20	3.40	3.30		
D1	2.95	3.15	3.05		
D2	2.30	2.70	2.50		
Е	3.20	3.40	3.30		
E1	2.95	3.15	3.05		
E2	1.60	2.00	1.80		
E3	0.95	1.35	1.15		
E4	0.10	0.30	0.20		
е	_	-	0.65		
k	0.50	0.90	0.70		
L	0.30	0.50	0.40		
θ	0°	12°	10°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (SWP) (Type UX)



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
X3	2.600
X4	3.500
Y	0.700
Y1	0.550
Y2	1.650
Y3	0.600
Y4	2.450
Y5	0.400
Y6	3.700

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.



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